

Product Change Notification

Change Title	Power IC Substituting Material Adoption	Date	2022/07/15	PCN No	F2224
PCN level:	Minor				
Models:	Listed in Affected Model Table				
Category:	Hardware - Power IC				

Description:

Due to **worldwide shortage of power ICs**, Innodisk will adopt substituting materials into our BOMs. All product families affected are listed in the following table. This PCN will affect all part numbers including standard and customized ones.

<u>Model Name</u>
M.2 (S42) 3IE7
M.2 (S42) 3TE7
InnoOSR M.2 (S42) 3TO7
M.2 (S42) 3TG6-P
M.2 (S80) 3MG2-P
M.2 (S80) 3SE2-P
M.2 (S80) 3TE7
M.2 (S80) 3IE7
InnoOSR M.2 (S80) 3TO7
InnoAGE M.2 (S80) 3TI7
M.2 (S80) 3TG6-P
mSATA mini 3TE7
mSATA 3SE2-P
mSATA 3MG2-P
mSATA 3TG6-P
1.8" SATA SSD 3SE
2.5" SATA SSD 3TG6-P
SATA Slim 3TG6-P
SATADOM-MH 3ME4
SATADOM-ML 3ME4
SATADOM-ML 3SE4
SATADOM-ML 3TG6-P
SATADOM-MV 3ME-S
SATADOM-SH 3ME4
SATADOM-SH Type C 3ME4
SATADOM-SV 3ME4
SATADOM-SH type D 3TE7
SATADOM-SL 3TE7
SATADOM-SH Type D 3ME4
SATADOM-SL 3ME4
SATADOM-SH 3TE7
SATADOM-SV 3TE7

Summary of Change

1. Add substituting material CYNTEC MUN3CAD03-SE Power IC for TI TPS82084SIL

Customer Impact of Change and Recommended Action:

Innodisk anticipates no negative impact to customer's application.

There is no functional implication to customer's application but improve reliability, and qualification of these changes may not be necessary.

Notes:

No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones.

Innodisk apologizes for any inconvenience caused by this and appreciate your understanding.

Innodisk promises that new items deliver quality and reliability for your application. If you have any further inquiry of our products or if you have any question about the specification of it, please contact Innodisk sales person.

Thank you for your confidence in Innodisk in the past and looking forward to serving you in the near future.

PCN Notice Revision History:

Date of Revision:	Revision Number:	Remark:
2022/07/15	F2224	First release

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